

# MOS FIELD EFFECT TRANSISTOR 2SK3984

## SWITCHING N-CHANNEL POWER MOSFET

### DESCRIPTION

The 2SK3984 is N-channel MOS Field Effect Transistor designed for high speed switching applications such as class-D amplifier.

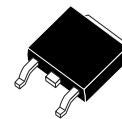
### ORDERING INFORMATION

| PART NUMBER | PACKAGE         |
|-------------|-----------------|
| 2SK3984-ZK  | TO-252 (MP-3ZK) |

### FEATURES

- Super low on-state resistance  
 $R_{DS(on)} = 71 \text{ m}\Omega \text{ TYP. (} V_{GS} = 10 \text{ V, } I_D = 9 \text{ A)}$   
 $R_{DS(on)} = 85 \text{ m}\Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 9 \text{ A)}$
- Low  $C_{iss}$ :  $C_{iss} = 750 \text{ pF TYP.}$

(TO-252)



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ )

|  |                |                        |                  |
|--|----------------|------------------------|------------------|
| Drain to Source Voltage ( $V_{GS} = 0 \text{ V}$ )   | $V_{DSS}$      | 100                    | V                |
| Gate to Source Voltage ( $V_{DS} = 0 \text{ V}$ )    | $V_{GSS}$      | $\pm 20$               | V                |
| Drain Current (DC) ( $T_C = 25^\circ\text{C}$ )      | $I_{D(DC)}$    | $\pm 18$               | A                |
| Drain Current (pulse) <sup>Note1</sup>               | $I_{D(pulse)}$ | $\pm 45$               | A                |
| Total Power Dissipation ( $T_C = 25^\circ\text{C}$ ) | $P_{T1}$       | 30                     | W                |
| Total Power Dissipation ( $T_A = 25^\circ\text{C}$ ) | $P_{T2}$       | 1.0                    | W                |
| Channel Temperature                                  | $T_{ch}$       | 150                    | $^\circ\text{C}$ |
| Storage Temperature                                  | $T_{stg}$      | $-55 \text{ to } +150$ | $^\circ\text{C}$ |
| Single Avalanche Energy <sup>Note2</sup>             | $E_{AS}$       | 10                     | mJ               |
| Repetitive Avalanche Current <sup>Note3</sup>        | $I_{AR}$       | 10                     | A                |
| Repetitive Avalanche Energy <sup>Note3</sup>         | $E_{AR}$       | 10                     | mJ               |

### THERMAL RESISTANCE

|                                       |                |      |                    |
|---------------------------------------|----------------|------|--------------------|
| Channel to Case Thermal Resistance    | $R_{th(ch-C)}$ | 125  | $^\circ\text{C/W}$ |
| Channel to Ambient Thermal Resistance | $R_{th(ch-A)}$ | 4.17 | $^\circ\text{C/W}$ |

**Notes 1.**  $PW \leq 10 \mu\text{s}$ , Duty Cycle  $\leq 1\%$

**2.** Starting  $T_{ch} = 25^\circ\text{C}$ ,  $V_{DD} = 50 \text{ V}$ ,  $R_G = 25 \Omega$ ,  $V_{GS} = 20 \rightarrow 0 \text{ V}$ ,  $L = 100 \mu\text{H}$

**3.**  $T_{ch(peak)} \leq 150^\circ\text{C}$ ,  $R_G = 25 \Omega$

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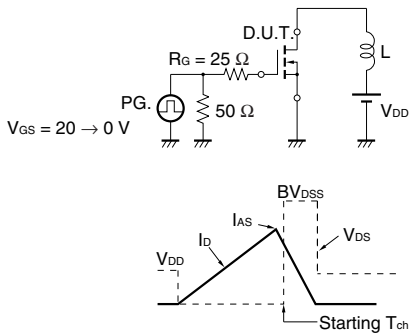
**ELECTRICAL CHARACTERISTICS (TA = 25°C)**

| CHARACTERISTICS                                 | SYMBOL        | TEST CONDITIONS                                 | MIN. | TYP. | MAX.     | UNIT             |
|---|---------------|---|------|------|----------|------------------|
| Zero Gate Voltage Drain Current                 | $I_{DSS}$     | $V_{DS} = 100\text{ V}, V_{GS} = 0\text{ V}$    |      |      | 10       | $\mu\text{A}$    |
| Gate Leakage Current                            | $I_{GSS}$     | $V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$ |      |      | $\pm 10$ | $\mu\text{A}$    |
| Gate Cut-off Voltage                            | $V_{GS(off)}$ | $V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$       | 4.5  | 5.5  | 6.5      | V                |
| Forward Transfer Admittance <b>Note</b>         | $ y_{fs} $    | $V_{DS} = 10\text{ V}, I_D = 9\text{ A}$        | 2.5  | 5.8  |          | S                |
| Drain to Source On-state Resistance <b>Note</b> | $R_{DS(on)}$  | $V_{GS} = 10\text{ V}, I_D = 9\text{ A}$        |      | 71   | 85       | $\text{m}\Omega$ |
| Input Capacitance                               | $C_{iss}$     | $V_{DS} = 10\text{ V}$                          |      | 750  |          | pF               |
| Output Capacitance                              | $C_{oss}$     | $V_{GS} = 0\text{ V}$                           |      | 120  |          | pF               |
| Reverse Transfer Capacitance                    | $C_{rss}$     | $f = 1\text{ MHz}$                              |      | 40   |          | pF               |
| Turn-on Delay Time                              | $t_{d(on)}$   | $V_{DD} = 50\text{ V}, I_D = 9\text{ A}$        |      | 15   |          | ns               |
| Rise Time                                       | $t_r$         | $V_{GS} = 10\text{ V}$                          |      | 6    |          | ns               |
| Turn-off Delay Time                             | $t_{d(off)}$  | $R_G = 10\ \Omega$                              |      | 17   |          | ns               |
| Fall Time                                       | $t_f$         |   |      | 5    |          | ns               |
| Total Gate Charge                               | $Q_G$         | $V_{DD} = 50\text{ V}$                          |      | 13   |          | nC               |
| Gate to Source Charge                           | $Q_{GS}$      | $V_{GS} = 10\text{ V}$                          |      | 5.5  |          | nC               |
| Gate to Drain Charge                            | $Q_{GD}$      | $I_D = 18\text{ A}$                             |      | 4    |          | nC               |
| Body Diode Forward Voltage <b>Note</b>          | $V_{F(S-D)}$  | $I_F = 18\text{ A}, V_{GS} = 0\text{ V}$        |      | 0.9  | 1.5      | V                |
| Reverse Recovery Time                           | $t_{rr}$      | $I_F = 18\text{ A}, V_{GS} = 0\text{ V}$        |      | 56   |          | ns               |
| Reverse Recovery Charge                         | $Q_{rr}$      | $di/dt = 100\text{ A}/\mu\text{s}$              |      | 146  |          | nC               |

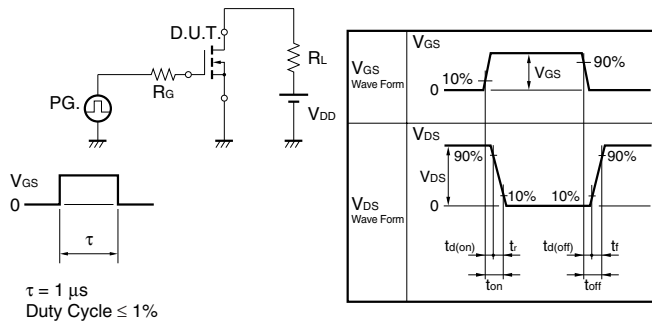
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**Note** Pulsed

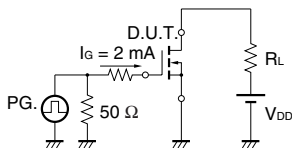
**TEST CIRCUIT 1 AVALANCHE CAPABILITY**



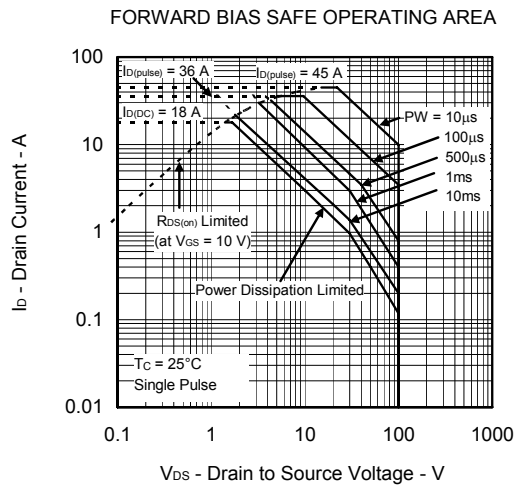
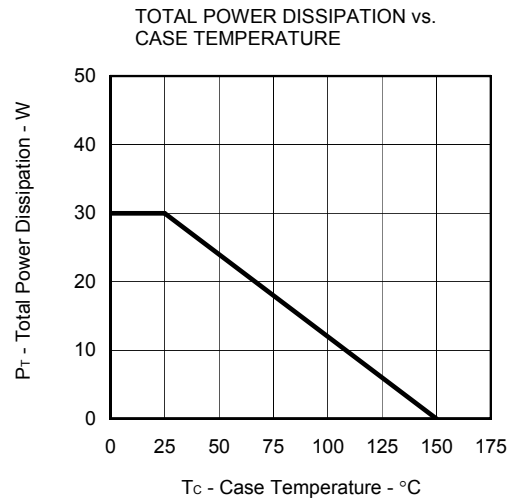
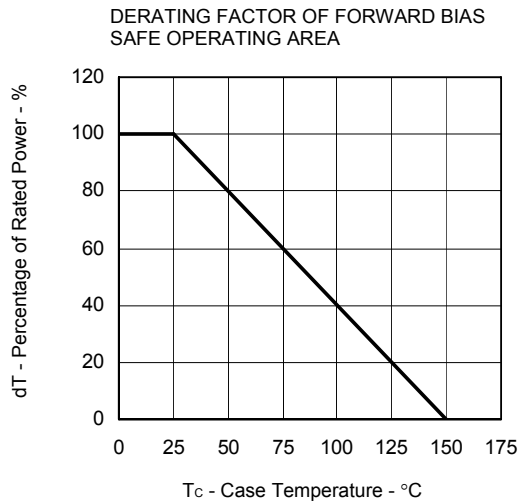
**TEST CIRCUIT 2 SWITCHING TIME**



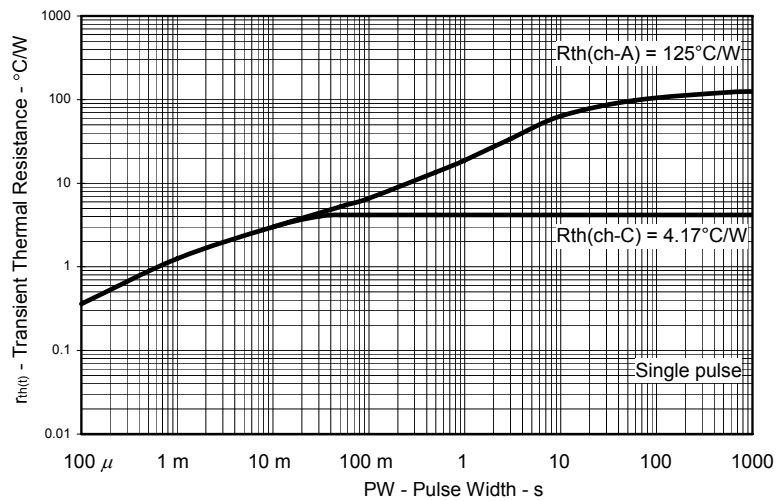
**TEST CIRCUIT 3 GATE CHARGE**



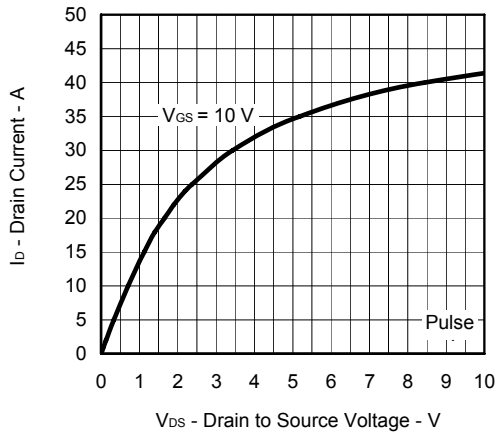
TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)



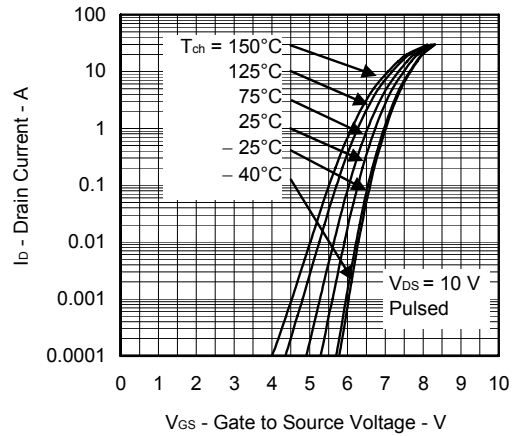
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



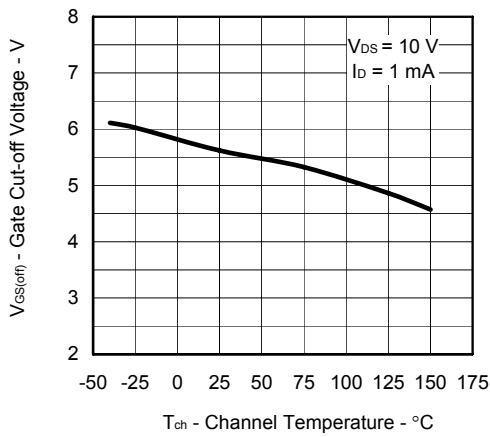
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



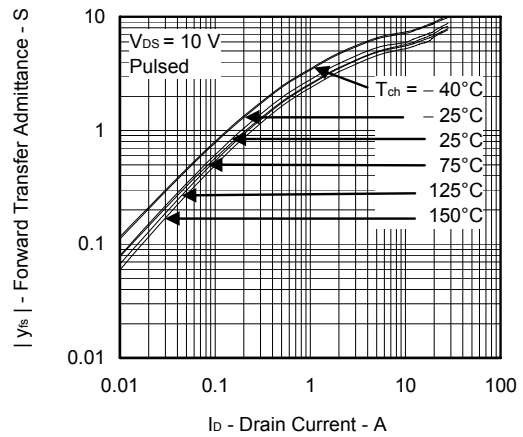
FORWARD TRANSFER CHARACTERISTICS



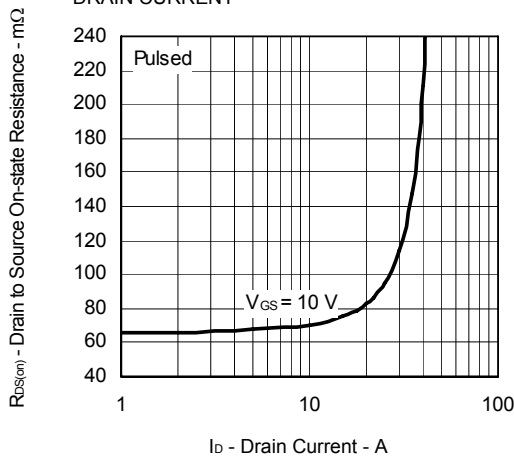
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



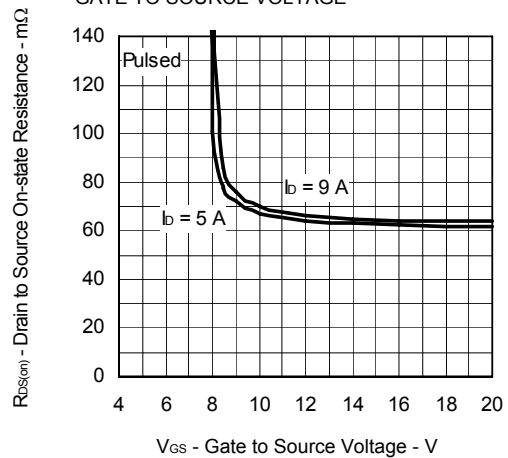
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

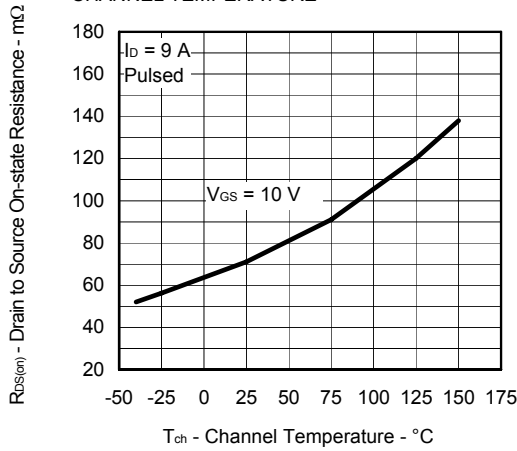


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

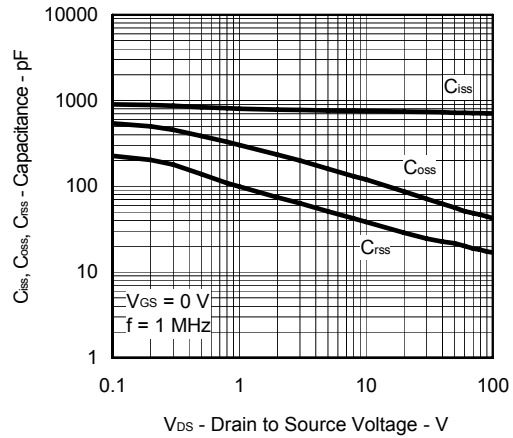


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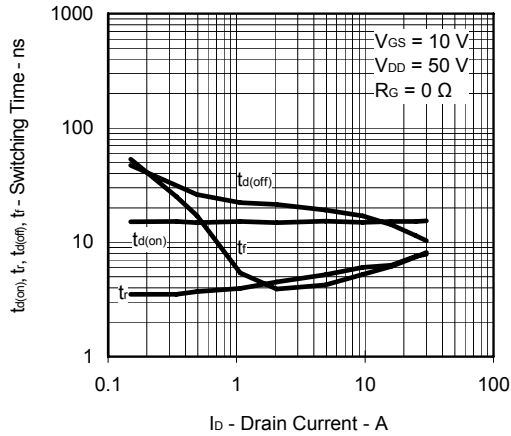
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



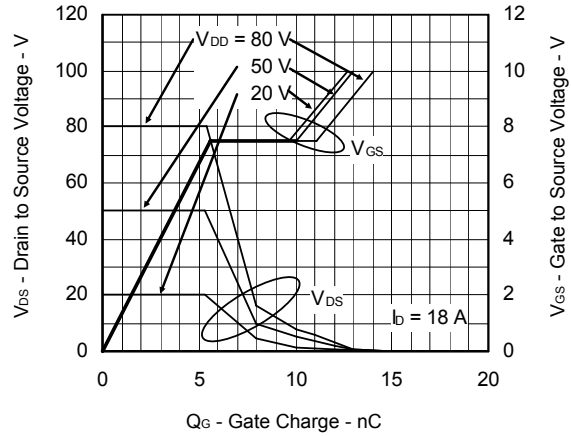
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



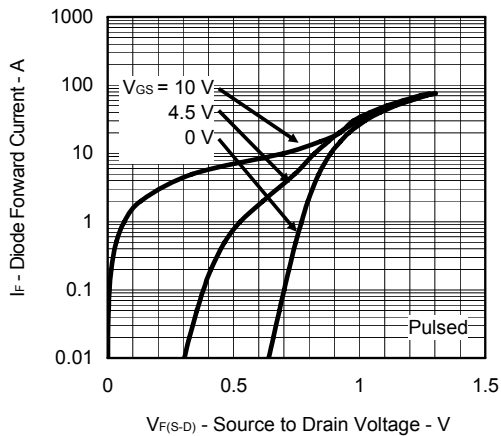
SWITCHING CHARACTERISTICS



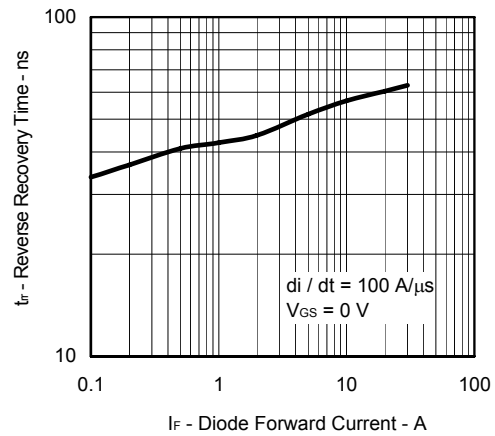
DYNAMIC INPUT/OUTPUT CHARACTERISTICS

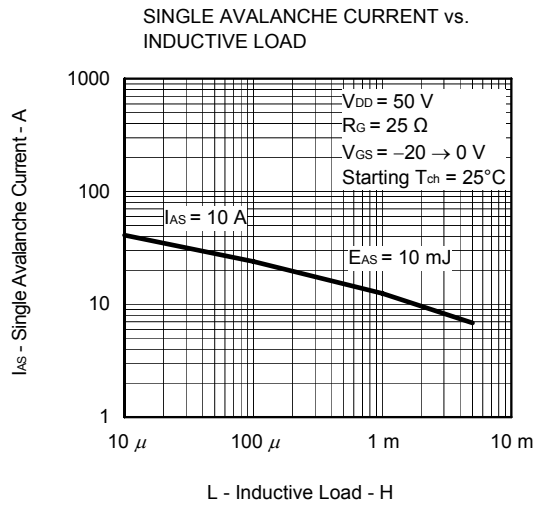


SOURCE TO DRAIN DIODE FORWARD VOLTAGE



REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT







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